



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

flowNPC 0 IGBT

1200 V / 75 A

Features

- Three-level topology
- High efficient with latest chip technology
- Low inductive package

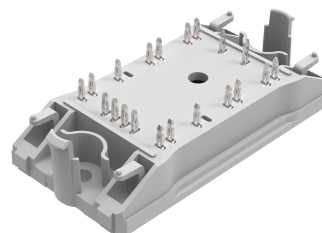
Target applications

- Solar Inverters

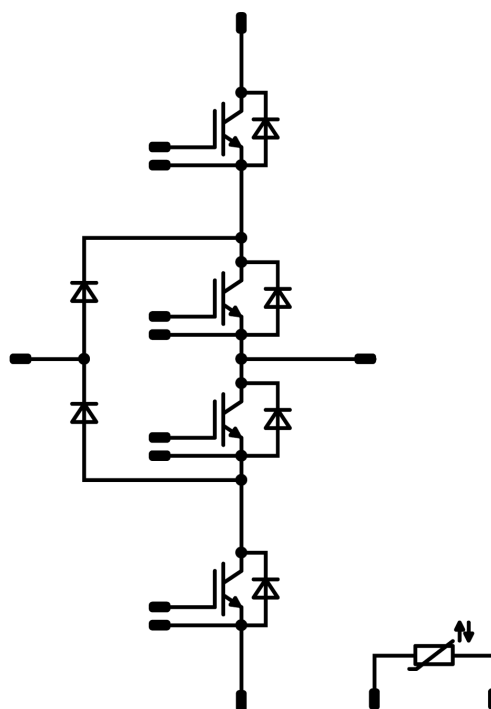
Types

- 10-PZ07NIA075S5-P926F53Y

flow 0 12 mm housing



Schematic





Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
-----------	--------	------------	-------	------

Buck Switch

Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	59	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	225	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	86	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	°C

Buck Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	55	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	71	W
Maximum junction temperature	T_{jmax}		175	°C

Boost Switch

Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	85	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	225	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	95	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	°C



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	48	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	100	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Maximum junction temperature	T_{jmax}		175	°C

Boost Sw. Inv. Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	47	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	100	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Maximum junction temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			9	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Buck Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00075	25	3,2	4	4,8	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		75	25 125 150		1,56 1,56 1,59	1,75 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			50	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		4500		pF
Output capacitance	C_{oes}							130		pF
Reverse transfer capacitance	C_{res}							17		pF
Gate charge	Q_g	$V_{CC} = 520 \text{ V}$	15		75	25		164		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,1		K/W
--	---------------	---	--	--	--	--	--	-----	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	± 15	350	75	25 125 150		56,8 57 55,8		ns
Rise time	t_r					25 125 150		9,8 12 12,8		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		79,6 94,6 99		ns
Fall time	t_f					25 125 150		20,24 26,4 32,08		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		0,286 0,549 0,651		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,733 1,13 1,28		mWs



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Buck Diode

Static

Forward voltage	V_F				75	25 125 150		1,53 1,49 1,46	1,92 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 650$ V				25			3,8	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,34		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt=8664$ A/µs $di/dt=7459$ A/µs $di/dt=7169$ A/µs	± 15	350	75	25 125 150		86,55 104,95 109,96		A
Reverse recovery time	t_{rr}					25 125 150		53,54 94,19 109,81		ns
Recovered charge	Q_r					25 125 150		2,37 4,56 5,29		µC
Reverse recovered energy	E_{rec}					25 125 150		0,567 1,06 1,21		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		3200 2640 2816		A/µs



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,001	25	4,2	5	5,8	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		75	25 125 150		1,1 1,09 1,09	1,45 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			40	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		11625		pF
Reverse transfer capacitance	C_{res}							30		pF
Gate charge	Q_g		15	520	75	25		436		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1		K/W
--	---------------	---	--	--	--	--	--	---	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	± 15	350	75	25 125 150		106 105 106		ns
Rise time	t_r					25 125 150		8 10 10		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		179 207 215		ns
Fall time	t_f					25 125 150		29,2 183,13 224,51		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		0,467 0,572 0,644		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		3,17 4,56 4,99		mWs



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Boost Diode

Static

Forward voltage	V_F				50	25 125 150		1,5 1,44 1,42	1,92 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 650$ V				25			2,65	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,41		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt=9000$ A/µs $di/dt=7880$ A/µs $di/dt=7092$ A/µs	± 15	350	75	25 125 150		79,42 93,32 98,46		A
Reverse recovery time	t_{rr}					25 125 150		52,76 93,32 107,64		ns
Recovered charge	Q_r					25 125 150		2,17 3,9 4,57		µC
Reverse recovered energy	E_{rec}					25 125 150		0,505 1,02 1,21		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		3121 2046 1944		A/µs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Boost Sw. Inv. Diode

Static

Forward voltage	V_F				50	25 125	1,18	1,63 1,54	1,82 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25			0,6	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,4		K/W
--	---------------	---------------------------------------	--	--	--	--	--	-----	--	-----

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484$ Ω				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ± 1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ± 1 %						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

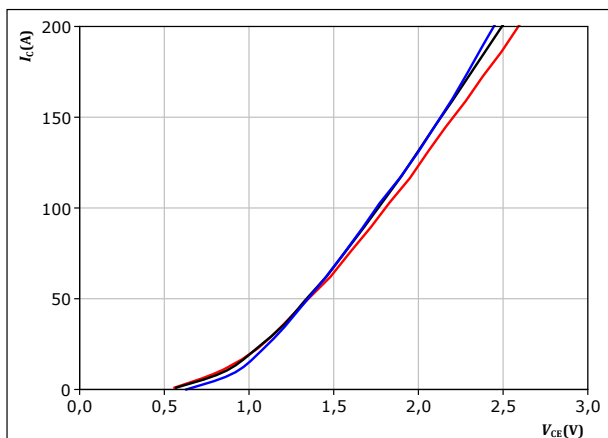
Buck Switch Characteristics

figure 1.

IGBT

Typical output characteristics

$$I_c = f(V_{CE})$$



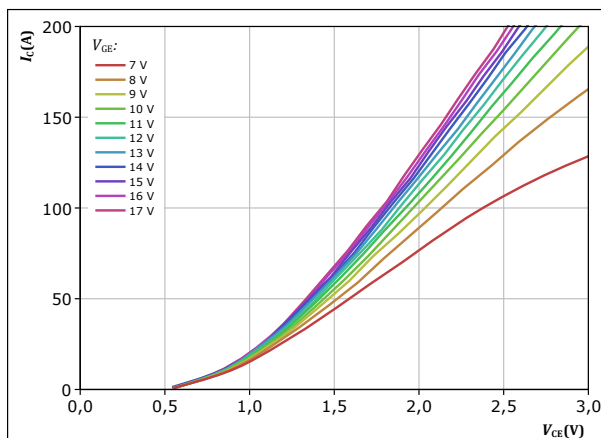
$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 2.

IGBT

Typical output characteristics

$$I_c = f(V_{CE})$$



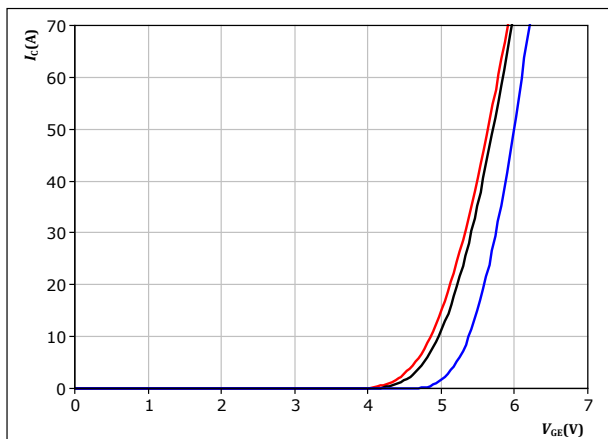
$t_p = 250 \mu s$
 $T_j = 150 ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3.

IGBT

Typical transfer characteristics

$$I_c = f(V_{GE})$$



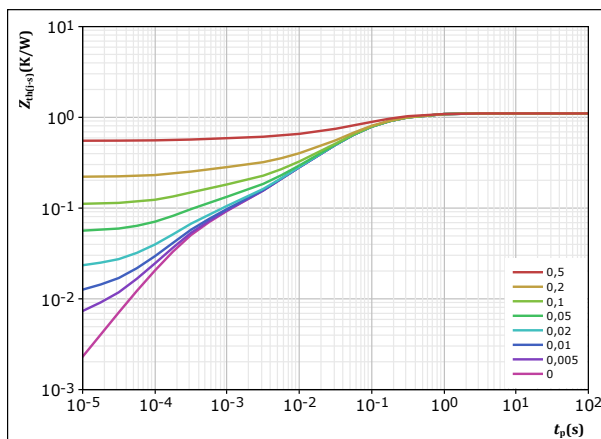
$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 4.

IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,104 K/W$
IGBT thermal model values

$R (K/W)$	$\tau (s)$
2,16E-01	4,05E-01
6,30E-01	6,87E-02
1,62E-01	1,13E-02
3,68E-02	2,51E-03
6,02E-02	3,09E-04



Vincotech

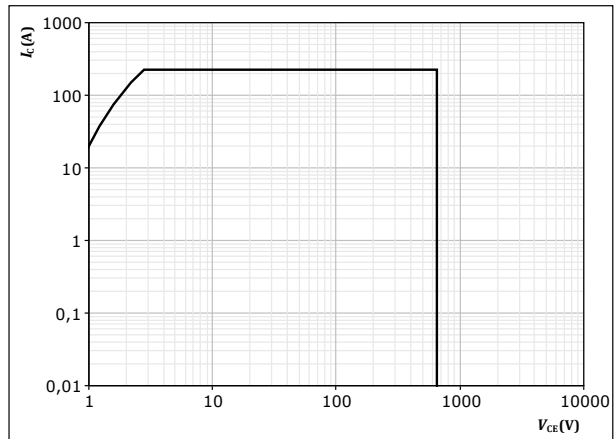
10-PZ07NIA075S5-P926F53Y
datasheet

Buck Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80 \text{ } ^\circ\text{C}$
 $V_{GE} = 15 \text{ V}$
 $T_j = T_{jmax}$



Vincotech

Buck Diode Characteristics

figure 6.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

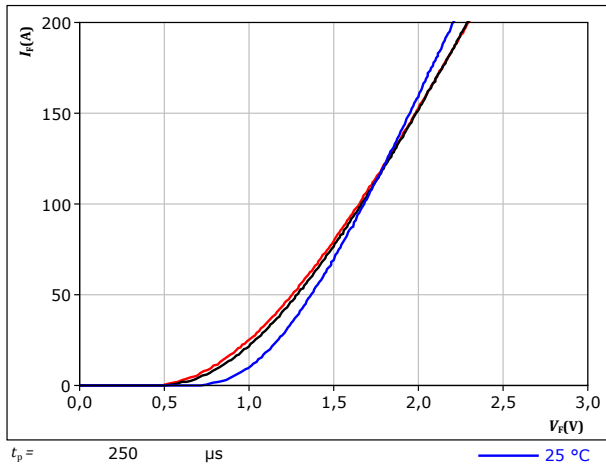
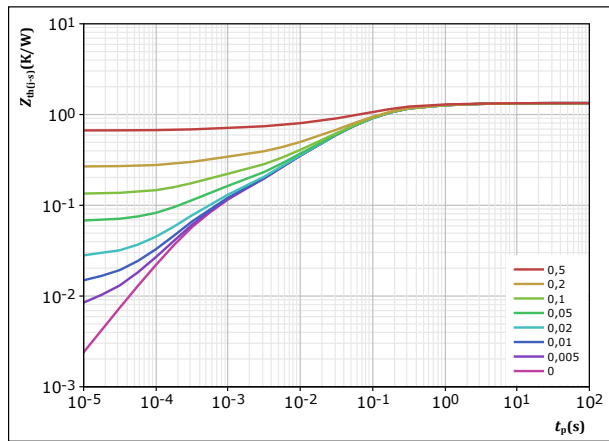


figure 7.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T
$R_{th(j-s)} =$	1,336 K/W
FWD thermal model values	
R (K/W)	τ (s)
5,84E-02	3,64E+00
1,57E-01	5,25E-01
5,86E-01	1,06E-01
3,27E-01	2,57E-02
1,27E-01	4,84E-03
8,12E-02	4,11E-04



Vincotech

10-PZ07NIA075S5-P926F53Y datasheet

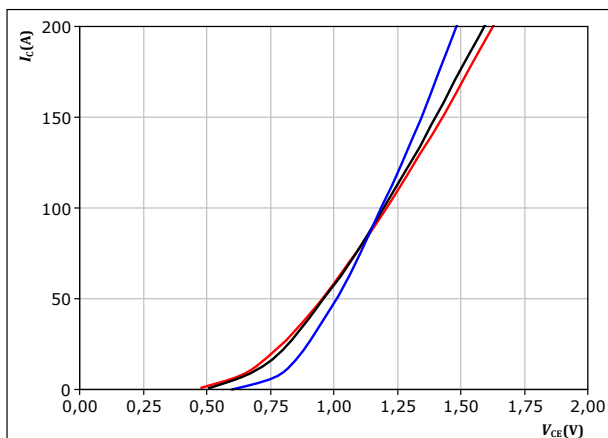
Boost Switch Characteristics

figure 8.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



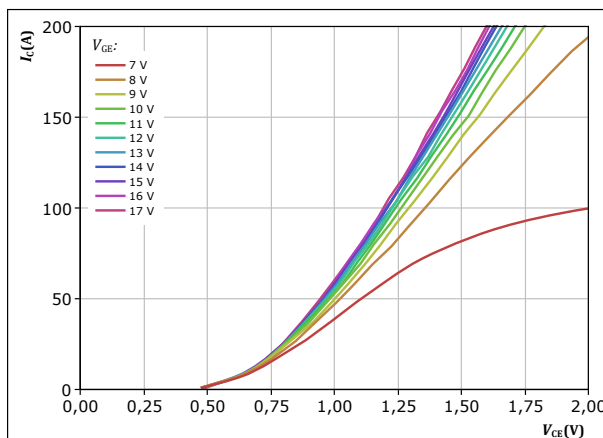
$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 9.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



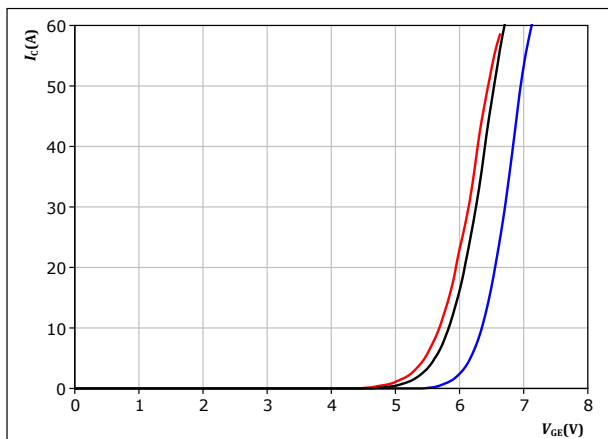
$t_p = 250 \mu s$
 $T_j = 150 ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 10.

IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



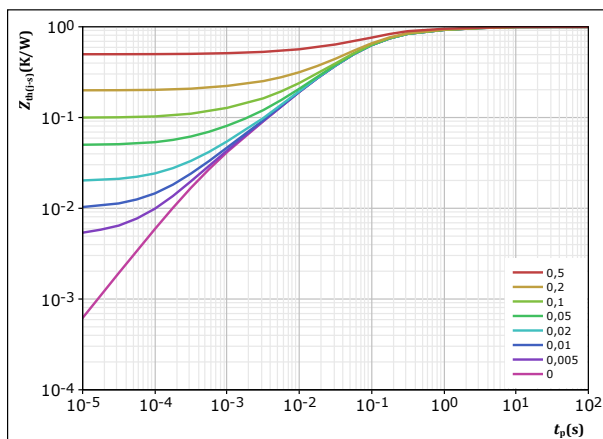
$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 11.

IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,996 K/W$
IGBT thermal model values

$R (K/W)$	$\tau (s)$
8,80E-02	2,68E+00
1,67E-01	3,70E-01
5,38E-01	8,09E-02
1,47E-01	1,56E-02
3,80E-02	3,42E-03
1,88E-02	5,45E-04



Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

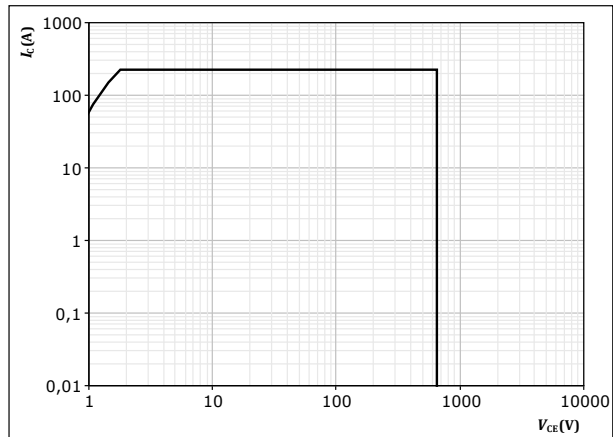
Boost Switch Characteristics

figure 12.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80 \text{ } ^\circ\text{C}$
 $V_{GE} = 15 \text{ V}$
 $T_j = T_{jmax}$



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

Boost Diode Characteristics

figure 13.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

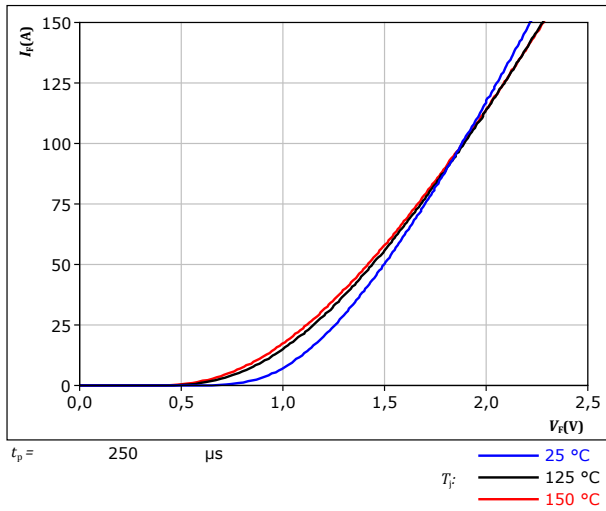
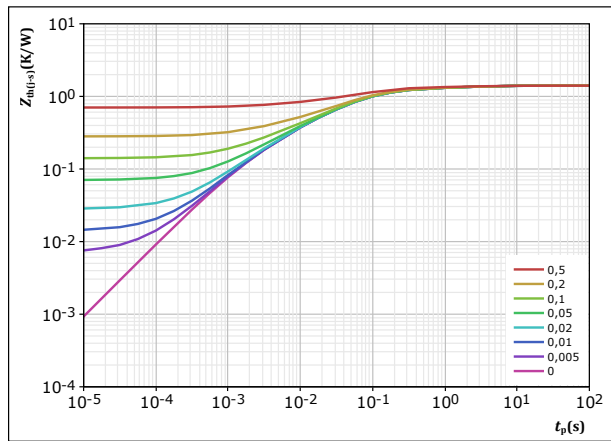


figure 14.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T
$R_{th(j-s)} =$	1,406 K/W
FWD thermal model values	
R (K/W)	τ (s)
8,12E-02	4,01E+00
1,48E-01	6,15E-01
5,58E-01	9,08E-02
3,75E-01	2,92E-02
1,82E-01	6,56E-03
6,20E-02	1,34E-03



Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

Boost Sw. Inv. Diode Characteristics

figure 15. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

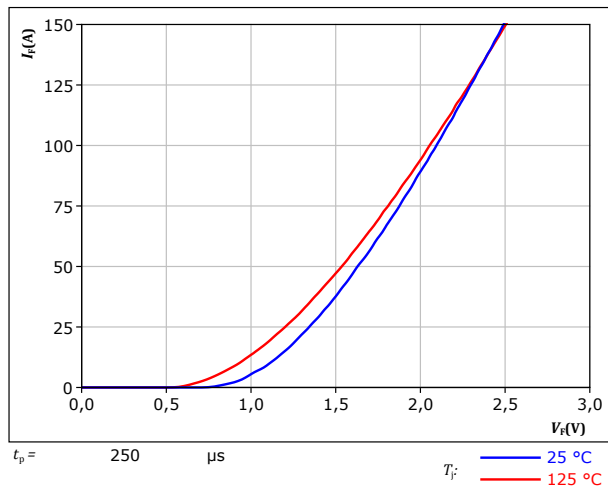
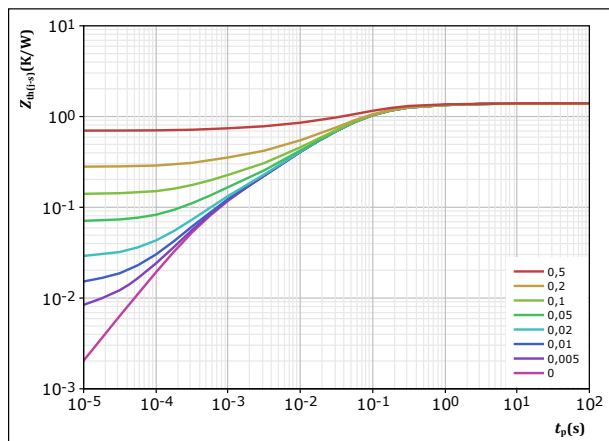


figure 16. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	1,399	K/W
FWD thermal model values		
R (K/W)	τ (s)	
6,76E-02	3,05E+00	
1,79E-01	3,50E-01	
6,70E-01	7,08E-02	
2,72E-01	1,81E-02	
1,35E-01	4,13E-03	
7,56E-02	5,11E-04	



Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

Thermistor Characteristics

figure 17.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





Vincotech

10-PZ07NIA075S5-P926F53Y datasheet

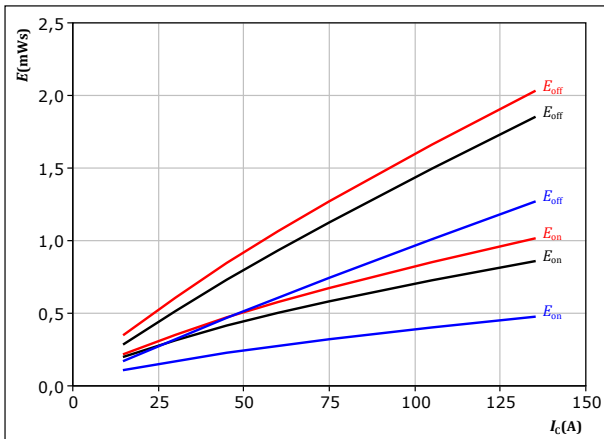
Buck Switching Characteristics

figure 18.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$
 $R_{goff} = 4 \text{ } \Omega$

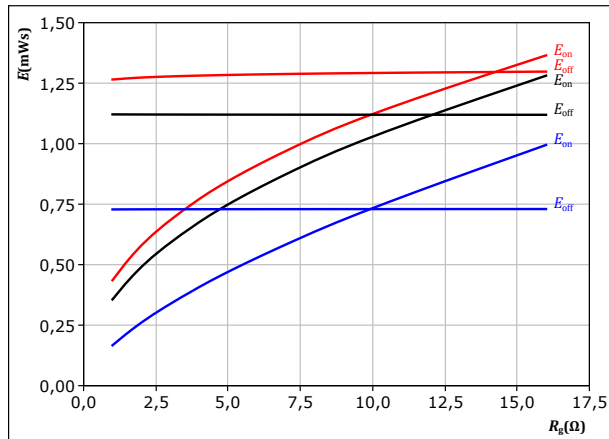
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 19.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 75 \text{ A}$

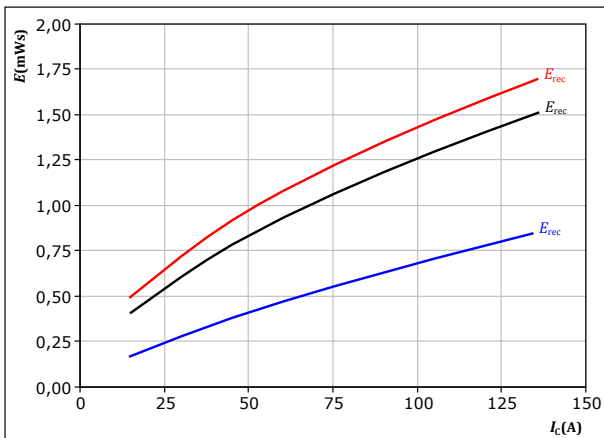
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 20.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$

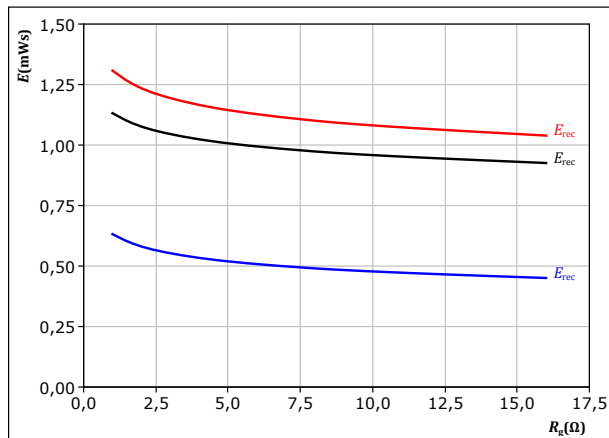
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 21.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 75 \text{ A}$

T_j :
— 25 °C
— 125 °C
— 150 °C



Vincotech

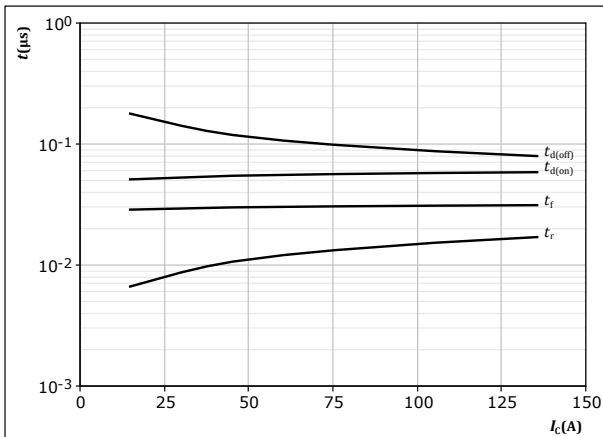
10-PZ07NIA075S5-P926F53Y datasheet

Buck Switching Characteristics

figure 22.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



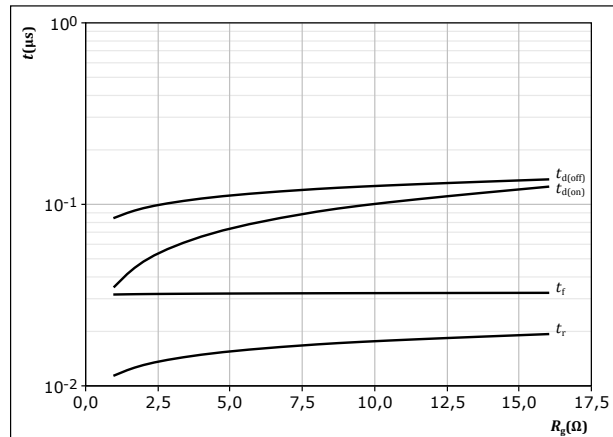
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 23.

IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$



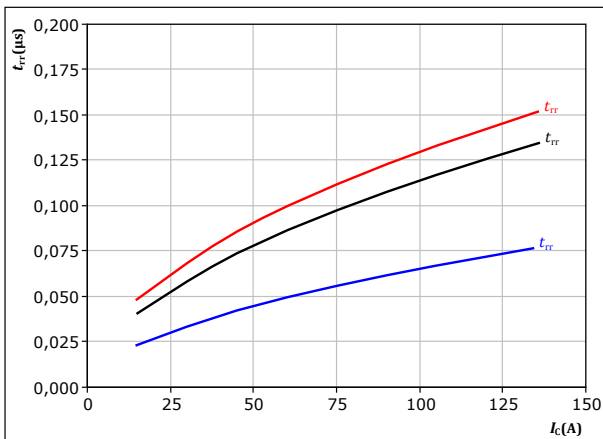
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

figure 24.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at

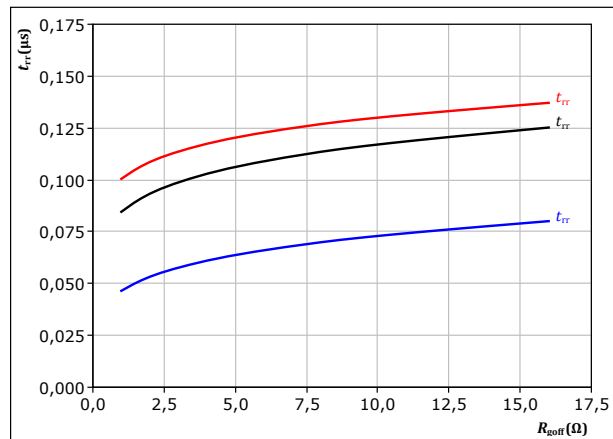
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C
125 °C
150 °C

figure 25.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j : 25 °C
125 °C
150 °C



Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

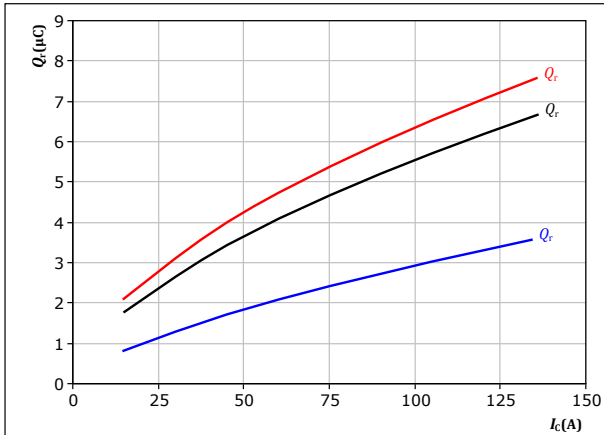
Buck Switching Characteristics

figure 26.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

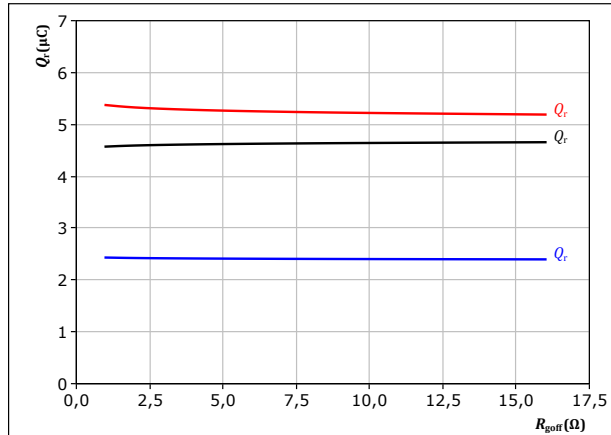
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 27.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 75$ A

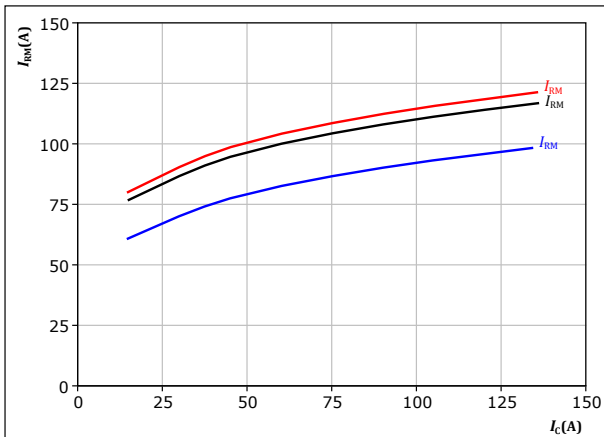
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 28.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

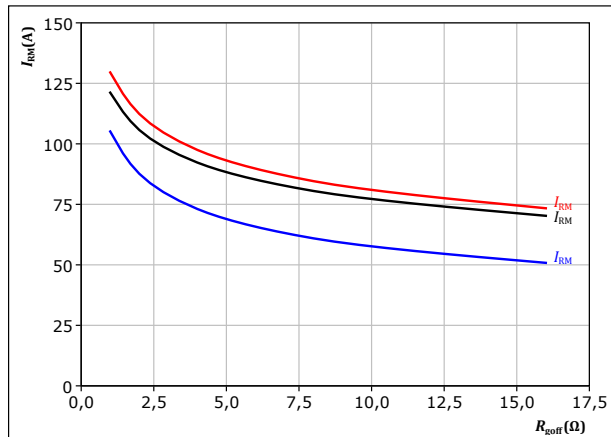
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 29.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 75$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



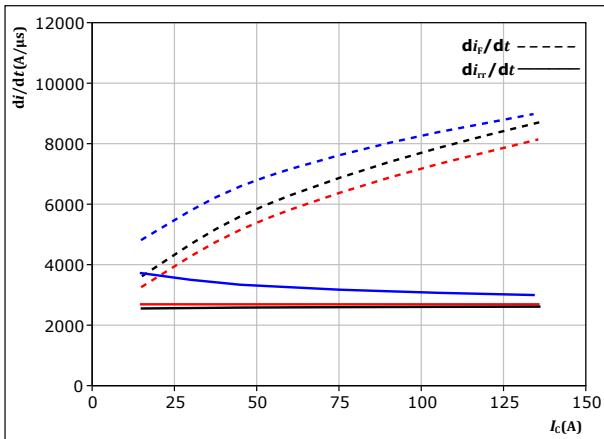
Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

Buck Switching Characteristics

figure 30. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



With an inductive load at

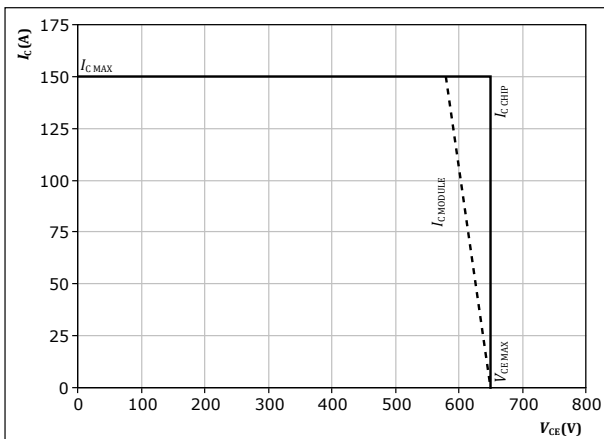
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 31. FWD

Reverse bias safe operating area

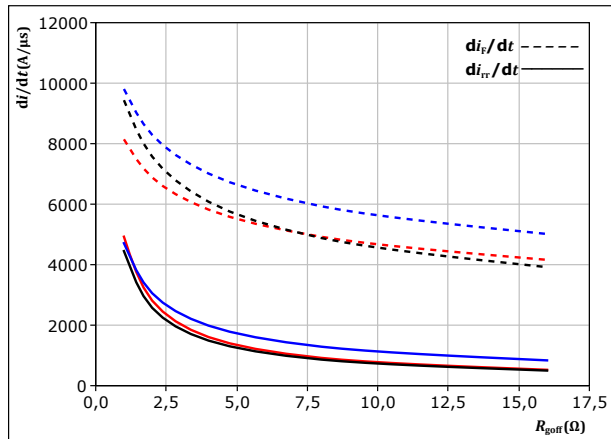
$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 32. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



Vincotech

10-PZ07NIA075S5-P926F53Y datasheet

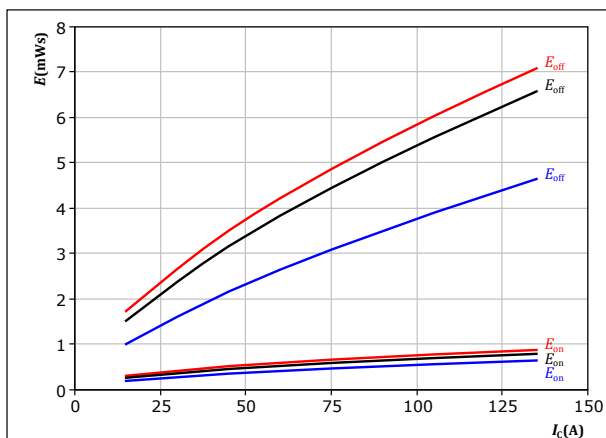
Boost Switching Characteristics

figure 33.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

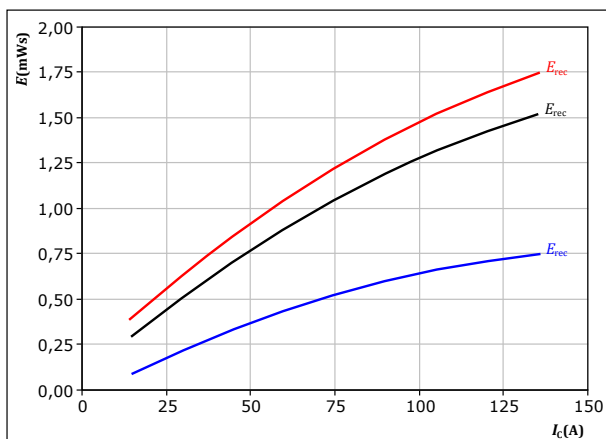
T_j : 25 °C
125 °C
150 °C

figure 35.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

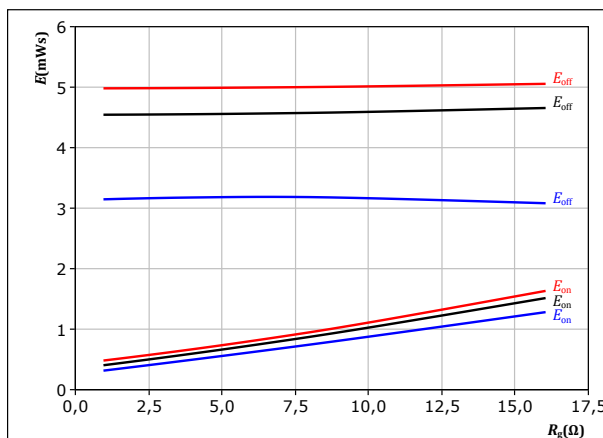
T_j : 25 °C
125 °C
150 °C

figure 34.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 75$ A

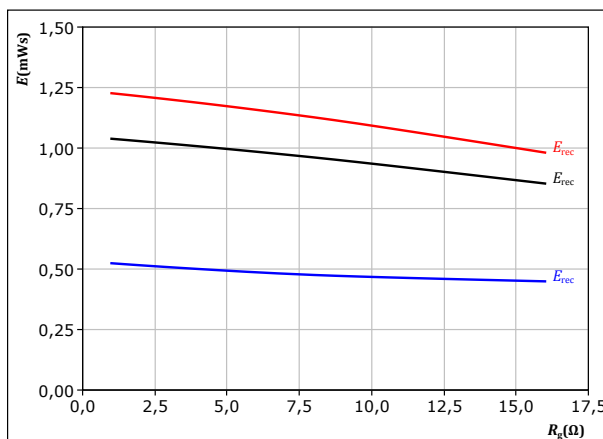
T_j : 25 °C
125 °C
150 °C

figure 36.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 75$ A

T_j : 25 °C
125 °C
150 °C



Vincotech

10-PZ07NIA075S5-P926F53Y datasheet

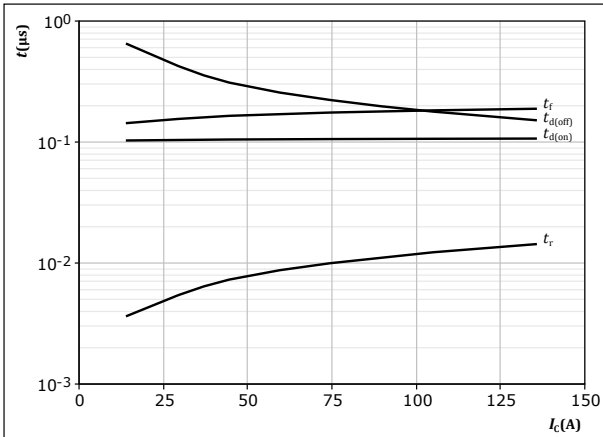
Boost Switching Characteristics

figure 37.

IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



With an inductive load at

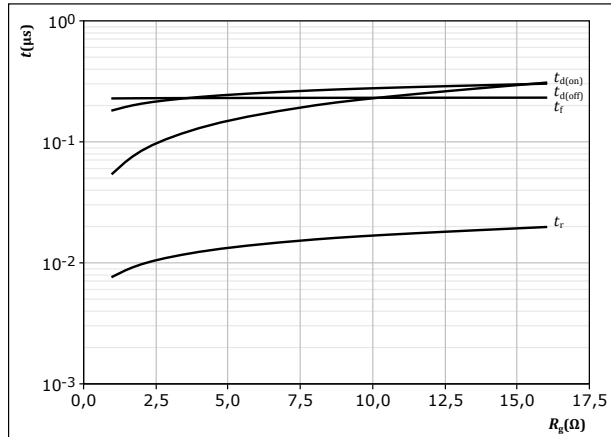
$T_j = 150 \text{ }^{\circ}\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$
 $R_{goff} = 4 \text{ } \Omega$

figure 38.

IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



With an inductive load at

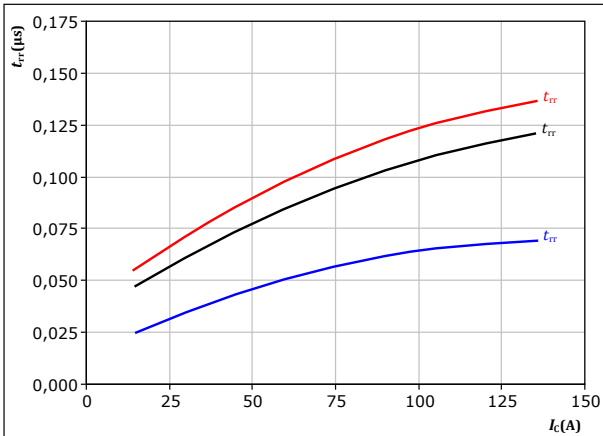
$T_j = 150 \text{ }^{\circ}\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 75 \text{ A}$

figure 39.

FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$

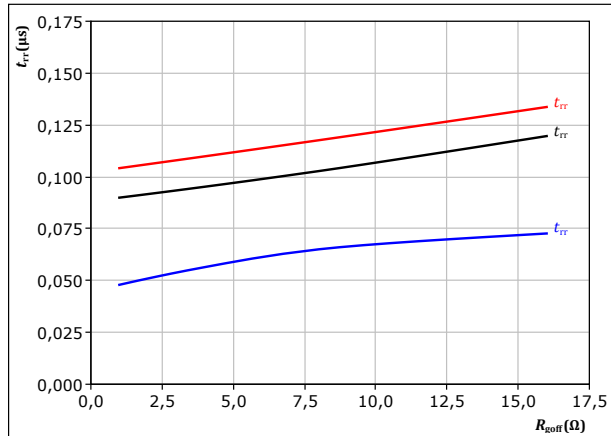
T_j : 25 °C
 125 °C
 150 °C

figure 40.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor

$$t_{rr} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 75 \text{ A}$

T_j : 25 °C
 125 °C
 150 °C



Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

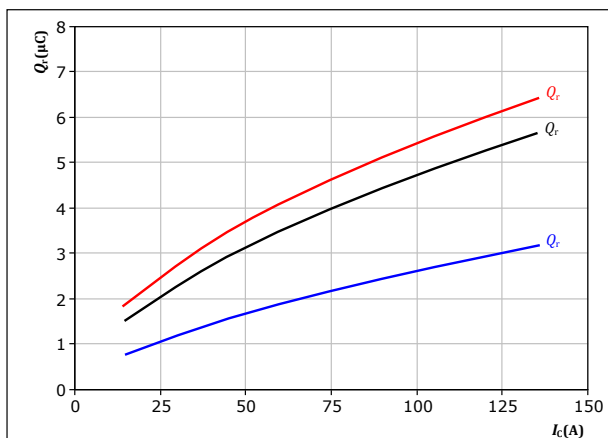
Boost Switching Characteristics

figure 41.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

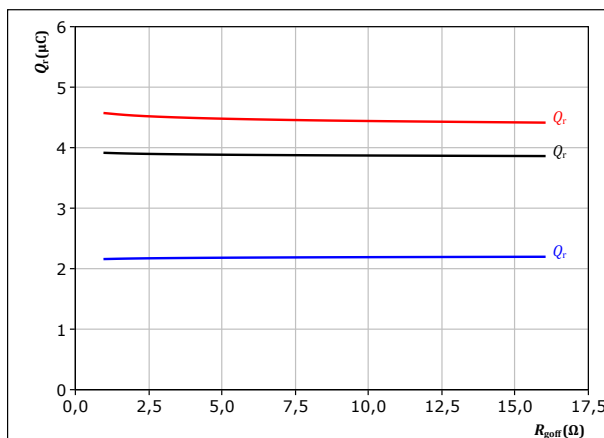
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 42.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

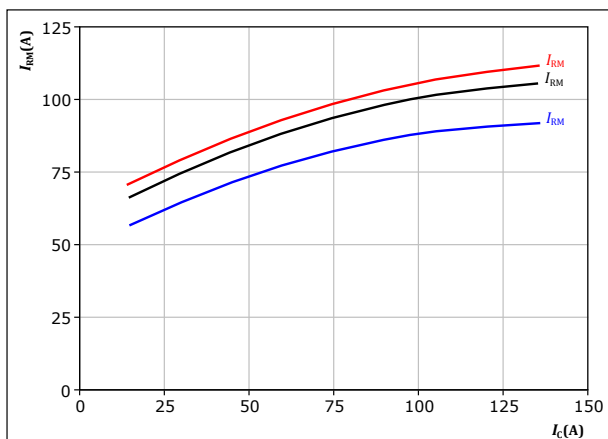
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 43.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

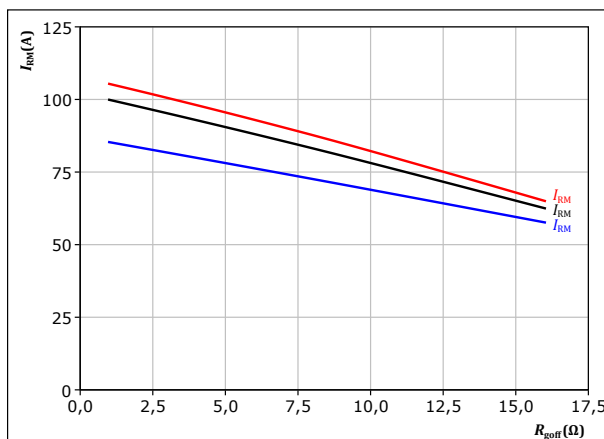
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 44.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



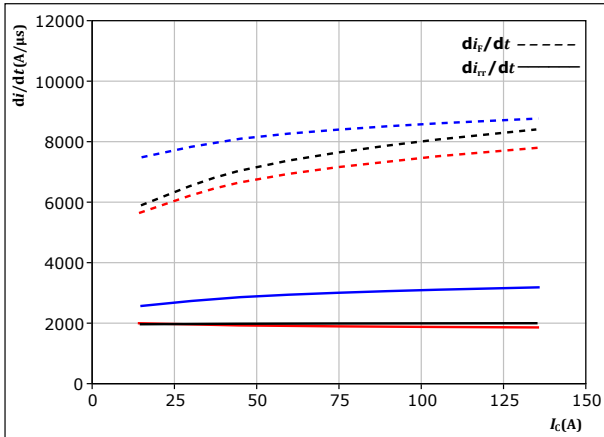
Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

Boost Switching Characteristics

figure 45. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



With an inductive load at

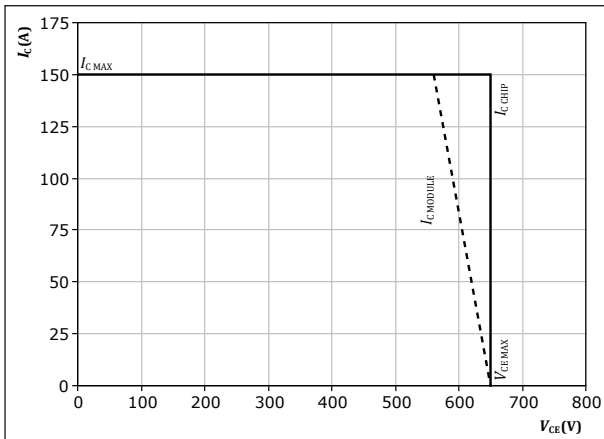
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 4$ Ω

T_j : 25 °C
125 °C
150 °C

figure 47. IGBT

Reverse bias safe operating area

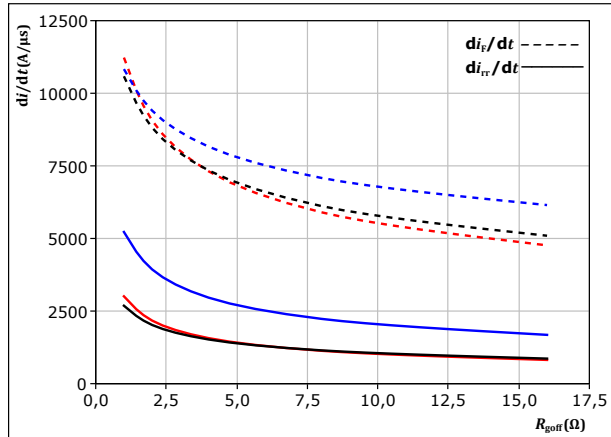
$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{goff} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 46. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 75$ A

T_j : 25 °C
125 °C
150 °C



Vincotech

10-PZ07NIA075S5-P926F53Y datasheet

Switching Definitions

figure 48. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

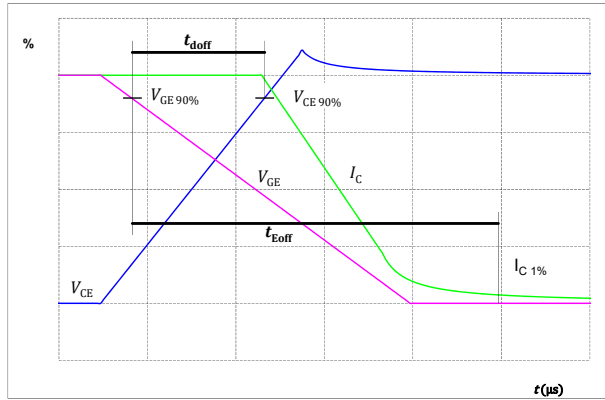


figure 49. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



figure 50. IGBT

Turn-off Switching Waveforms & definition of t_f

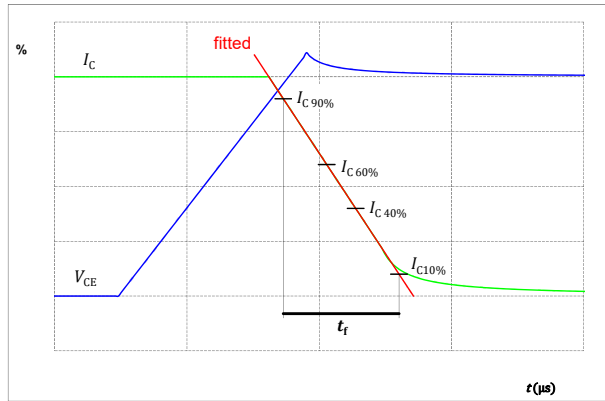
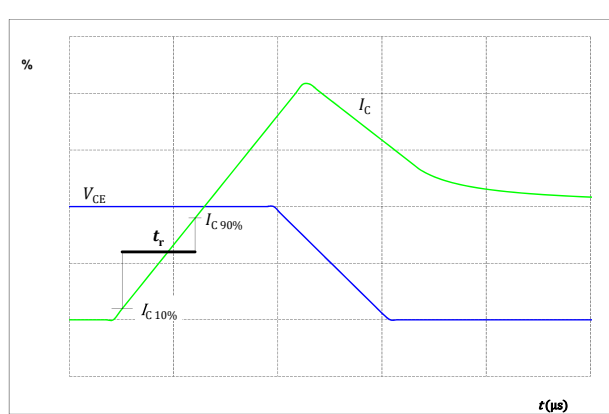


figure 51. IGBT

Turn-on Switching Waveforms & definition of t_r





Vincotech

Switching Definitions

figure 52.

FWD

Turn-off Switching Waveforms & definition of t_{rr}

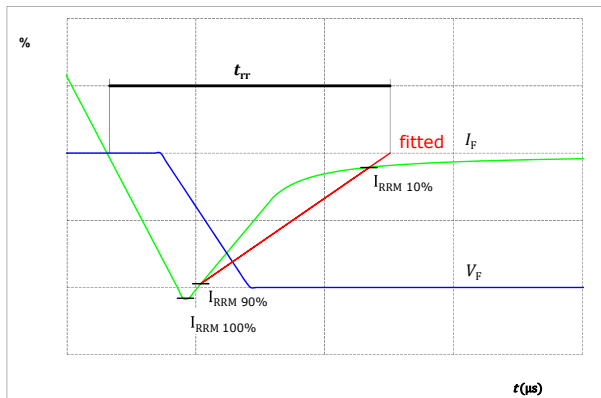
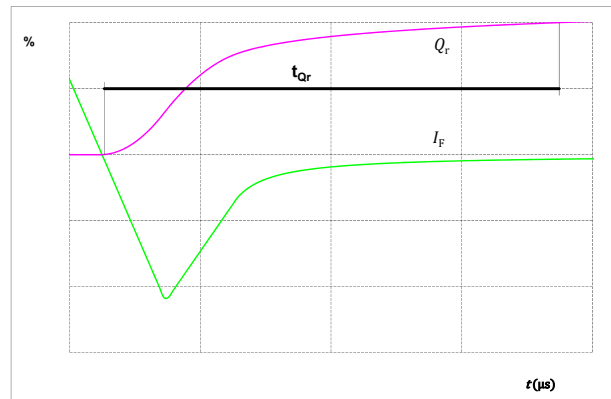


figure 53.

FWD


Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-PZ07NIA075SS-P926F53Y
With thermal paste (5,2 W/mK, PTM6000HV)	10-PZ07NIA075SS-P926F53Y-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-PZ07NIA075SS-P926F53Y-/3/

Marking							
	Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTV		WWYY	UL VIN	LLLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
		TTTTTTVV	LLLLL	SSSS	WWYY		

Pin table [mm]

Pin	X	Y	Function
1	33,6	0	G12
2	30,8	0	S12
3	22	0	DC-
4	19,2	0	DC-
5	10,1	0	GND
6	2,8	0	S14
7	0	0	G14
8	0	7,1	Ph
9	0	9,9	Ph
10	0	12,7	Ph
11	0	15,5	Ph
12	0	22,6	G13
13	2,8	22,6	S13
14	10,1	22,6	GND
15	19,2	22,6	DC+
16	22	22,6	DC+
17	30,8	22,6	S11
18	33,6	22,6	G11
19	33,6	14,8	Therm1
20	33,6	8,2	Therm2
21	not assembled		
22	not assembled		

Outline

The technical drawing shows the sensor module from two perspectives. The top view illustrates the rectangular footprint with dimensions 113 mm in the Y-direction and 68 mm in the X-direction. It details the locations of 22 pins, with pins 1-12 on the left side and pins 13-22 on the right side. Pins 19 and 20 are labeled as thermistors. The side view shows the module's profile with a height of 12.93 ± 0.1 mm and a base thickness of 6.2 ± 0.5 mm. It highlights the press-fit pinhead at the center and provides a reference to the handling instruction for connection parameters.

Tolerance of pinpositions: ±0.5mm at the end of pins
 Dimension of coordinate axis is only offset without tolerance

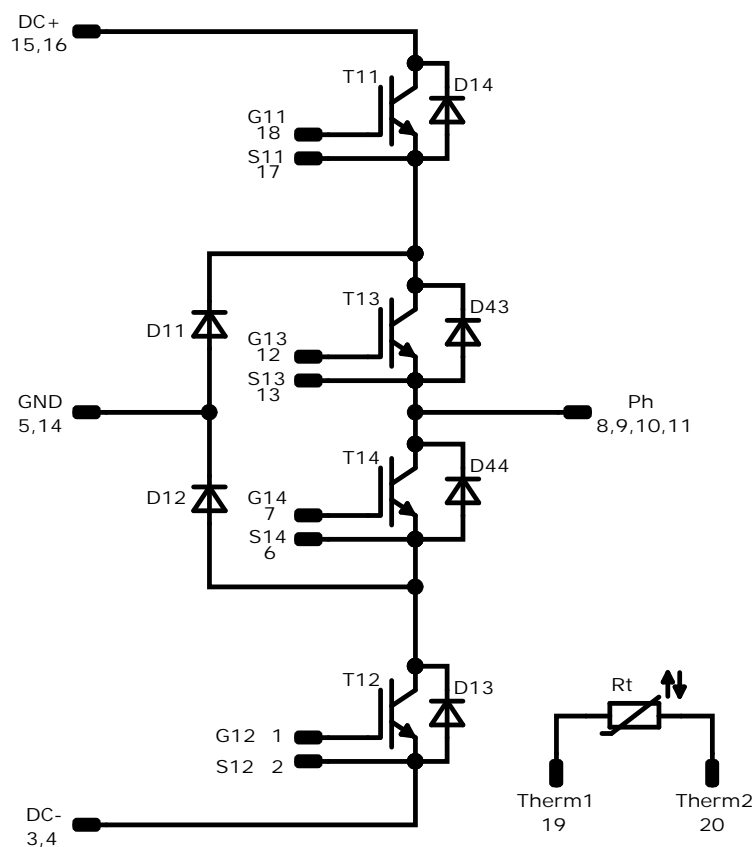


Vincotech

10-PZ07NIA075S5-P926F53Y

datasheet

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12	IGBT	650 V	75 A	Buck Switch	
D11, D12	FWD	650 V	75 A	Buck Diode	
T13, T14	IGBT	650 V	75 A	Boost Switch	
D13, D14	FWD	650 V	50 A	Boost Diode	
D44, D43	FWD	650 V	50 A	Boost Sw. Inv. Diode	
Rt	NTC			Thermistor	



Vincotech

10-PZ07NIA075S5-P926F53Y
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 0</i> packages see vincotech.com website.

Package data
Package data for <i>flow 0</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-PZ07NIA075S5-P926F53Y-D2-14	20 Dec. 2021	New Datasheet format, module is unchanged	

DISCLAIMER

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.